



S1MSWFQ

1.0A SURFACE-MOUNT GLASS PASSIVATED RECTIFIER

Product Summary (@TA = +25°C)

V _{RRM} (V)	I _O (A)	V _F Max (V)	I _R Max (μA)	
1,000	1	1.1	10	

Features and Benefits

- Glass Passivated Die Construction
- Ideally Suited for Automated Assembly
- Small Form Factor, Low Profile
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The S1MSWFQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Description and Applications

The S1MSWFQ is a rectifier packaged in the SOD123F package. Providing high reverse breakdown voltage and high current capability for standard rectification, this device is ideal for use in applications such as:

- Reverse protections
- Blocking

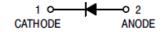
Mechanical Data

- Package: SOD123F
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 @3
- Polarity: Cathode Band
- Weight: 0.016 grams (Approximate)

SOD123F (Type B)







Top View

Bottom View

Schematic View

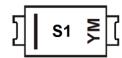
Ordering Information (Note 4)

Orderable Part Number	Package	Packing			
Orderable Fart Number	Package	Qty.	Carrier		
S1MSWFQ-7	SOD123F (Type B)	3,000	Tape & Reel		

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



S1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex.: K = 2023) M = Month (ex: 9 = September)

Date Code Key

Date Code Rey												
Year	2015	-	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	С	-	K	L	М	N	Р	R	S	Т	U	V
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	1,000	V
RMS Reverse Voltage	V _{R(RMS)}	700	V
Average Rectified Output Current @T _A = +75°C	Io	1.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine Wave Superimposed on Rated Load	I _{FSM}	25	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 5)	$R_{ heta JC}$	13	°C/W
Thermal Resistance Junction to Ambient (Note 5)	$R_{ heta JA}$	78	°C/W
Operating and Storage Temperature Range	T_{J}, T_{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

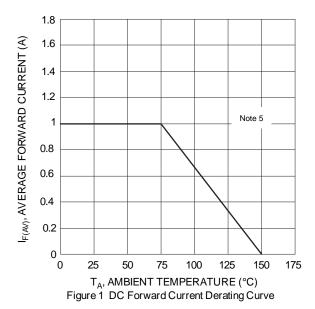
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	1,000	_	_	V	I _R = 5μA
Forward Voltage Drop	VF	_	0.98	1.1	V	I _F = 1A, T _J = +25°C
1 of ward voltage Brop	V F		0.88	_		I _F = 1A, T _J = +125°C
Leakage Current (Note 6)	1-	_	0.2	10		$V_R = 1,000V, T_J = +25^{\circ}C$
Leakage Current (Note 0)	IR	_	11	100	μΑ	$V_R = 1,000V, T_J = +125$ °C
Reverse Recovery Time	t _{RR}	_	1.0	_	μs	$I_F = 0.5A$, $I_R = 1.0A$, $I_{RR} = 0.25A$
Total Capacitance	C _T	_	6	_	pF	$V_R = 4.0V_{DC}$, $f = 1MHz$

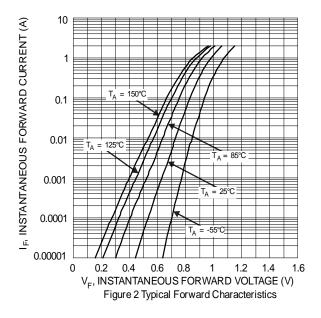
Notes:

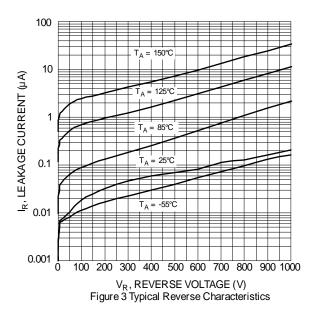
^{5.} Device mounted on FR4 PC board, 1 inch x 1 inch, 2oz. copper traces with 1x recommended pad layout, please see http://www.diodes.com/package-outlines.html for the latest version.

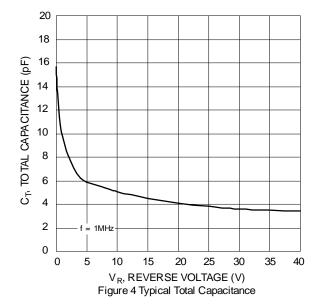
^{6.} Short duration pulse test used to minimize self-heating effect.









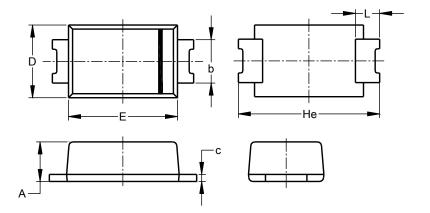




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123F (Type B)

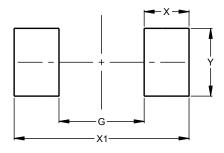


SOD123F (Type B)						
Dim	Min	Max	Тур			
Α	0.81	1.15				
b	0.80	1.35				
С	0.05	0.30				
D	1.70	1.90	1.80			
Е	2.60	2.80	2.70			
He	3.30	3.70	3.50			
L	0.35	0.85				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123F (Type B)



Dimensions	Value (in mm)
G	1.90
Х	1.00
X1	3.90
Υ	1.50



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